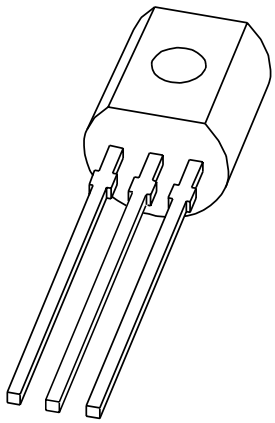
DATA SHEET



BSN254; BSN254A
N-channel enhancement mode vertical D-MOS transistor

Product specification
Supersedes data of 1997 Jun 23

2002 Feb 19

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N-channel enhancement mode vertical D-MOS transistor

BSN254; BSN254A

FEATURES

- Direct interface to C-MOS, TTL, etc.
- High-speed switching
- No secondary breakdown
- Low R_{DSon}.

APPLICATIONS

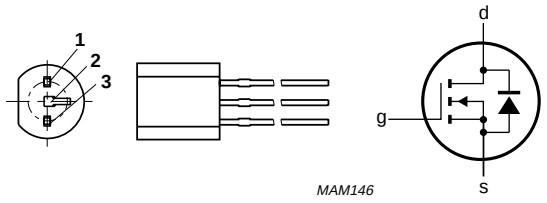
- Line current interruptor in telephone sets
- Relay, high-speed and line transformer drivers.

DESCRIPTION

N-channel enhancement mode vertical D-MOS transistor in a SOT54 (TO-92) variant package.

PINNING - SOT54 variant

PIN	DESCRIPTION	
	BSN254	BSN254A
1	gate	source
2	drain	gate
3	source	drain



note: various pinnings are available on request

Fig.1 Simplified outline and symbol.

QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
V_{DS}	drain-source voltage (DC)		–	250	V
I_D	drain current (DC)		–	310	mA
P_{tot}	total power dissipation	$T_{amb} \leq 25$ °C	–	1	W
R_{DSon}	drain-source on-state resistance	I_D = 300 mA; V_{GS} = 10 V	2.8	5	Ω
V_{GSth}	gate-source threshold voltage	I_D = 1 mA; $V_{DS} = V_{GS}$	–	2	V

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{DS}	drain-source voltage (DC)		–	250	V
V_{GSO}	gate-source voltage (DC)	open drain	–	±20	V
I_D	drain current (DC)		–	310	mA
I_{DM}	peak drain current		–	1.25	A
P_{tot}	total power dissipation	$T_{amb} \leq 25$ °C; note 1	–	1	W
T_{stg}	storage temperature		–55	+150	°C
T_j	junction temperature		–	150	°C

Note

1. Device mounted on a printed-circuit board; maximum lead length 4 mm; mounting pad for drain lead minimum 10×10 mm.

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	VALUE	UNIT
$R_{th\ j\text{-}a}$	thermal resistance from junction to ambient; note 1	125	K/W

Note

1. Device mounted on a printed-circuit board; maximum lead length 4 mm; mounting pad for drain lead minimum 10×10 mm.

CHARACTERISTICS

T_j = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$V_{(BR)DSS}$	drain-source breakdown voltage	I_D = 10 μA; V_{GS} = 0	250	–	–	V
I_{GSS}	gate-source leakage current	V_{GS} = ±20 V; V_{DS} = 0	–	–	±100	nA
V_{GSth}	gate-source threshold voltage	I_D = 1 mA; V_{DS} = V_{GS}	0.8	–	2	V
R_{DSon}	drain-source on-state resistance	I_D = 20 mA; V_{GS} = 2.4 V	–	–	7.5	Ω
		I_D = 300 mA; V_{GS} = 10 V	–	2.8	5	Ω
I_{DSS}	drain-source leakage current	V_{DS} = 200 V; V_{GS} = 0	–	–	1	μA
$\lvert Y_{fs} \rvert$	transfer admittance	I_D = 300 mA; V_{DS} = 25 V	200	600	–	mS
C_{iss}	input capacitance	V_{DS} = 25 V; V_{GS} = 0; f = 1 MHz	–	100	120	pF
C_{oss}	output capacitance	V_{DS} = 25 V; V_{GS} = 0; f = 1 MHz	–	21	30	pF
C_{rss}	feedback capacitance	V_{DS} = 25 V; V_{GS} = 0; f = 1 MHz	–	10	15	pF
Switching times (see Figs 2 and 3)						
t_{on}	turn-on time	I_D = 250 mA; V_{DD} = 50 V; V_{GS} = 0 to 10 V	–	6	10	ns
t_{off}	turn-off time	I_D = 250 mA; V_{DD} = 50 V; V_{GS} = 10 to 0 V	–	47	60	ns

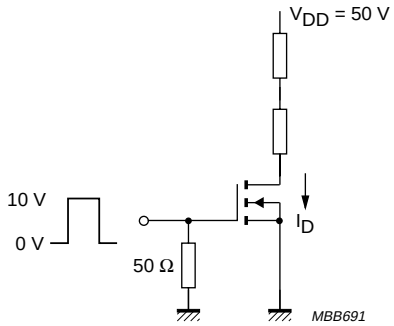


Fig.2 Switching times test circuit.

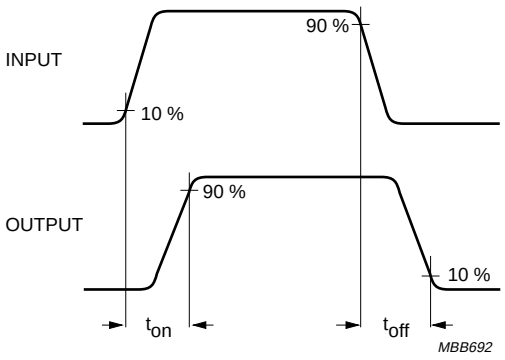


Fig.3 Input and output waveforms.

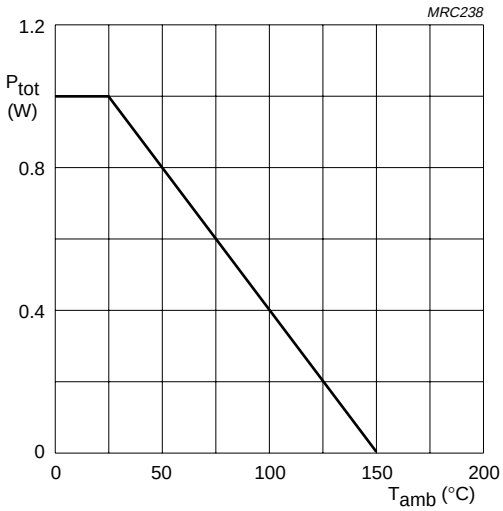
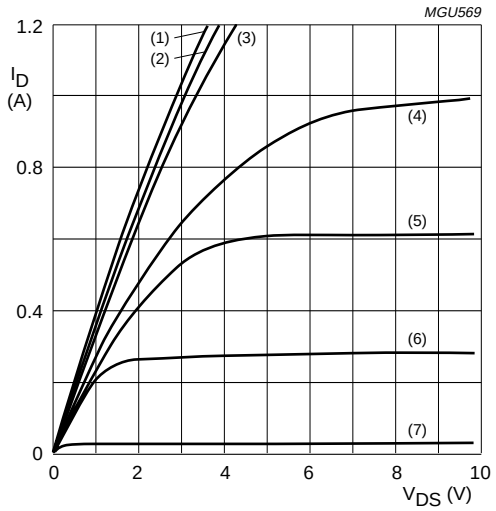


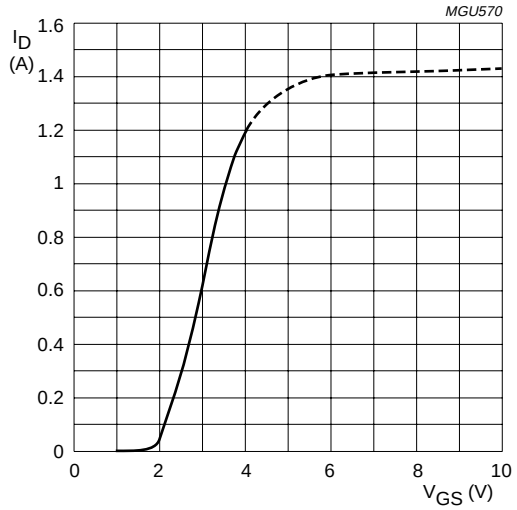
Fig.4 Power derating curve.



T_j = 25 °C.

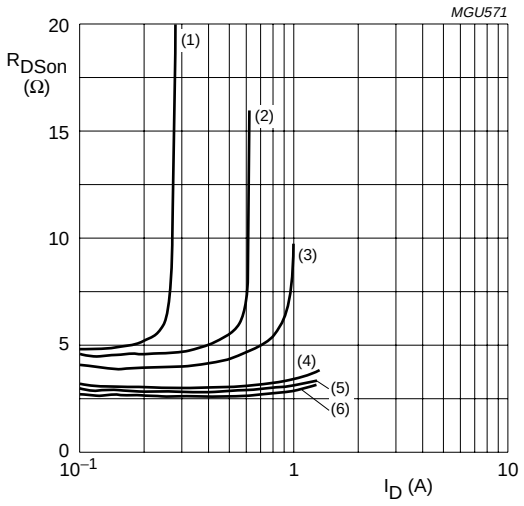
(1) V_{GS} = 10 V.
(2) V_{GS} = 5 V.
(3) V_{GS} = 4 V.
(4) V_{GS} = 3.5 V.
(5) V_{GS} = 3 V.
(6) V_{GS} = 2.5 V.
(7) V_{GS} = 2 V.

Fig.5 Typical output characteristics.



V_{DS} = 10 V; T_j = 25 °C.

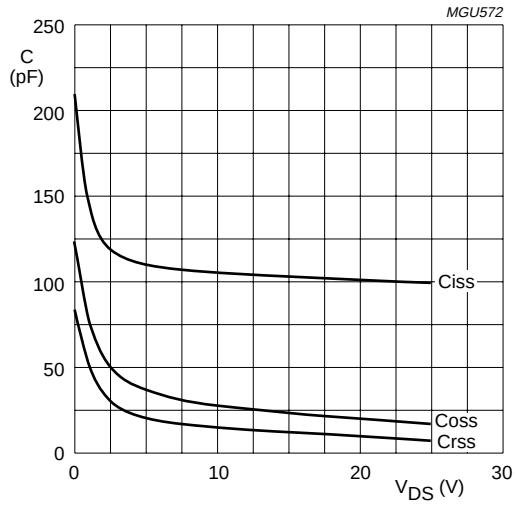
Fig.6 Typical transfer characteristics.



T_j = 25 °C.

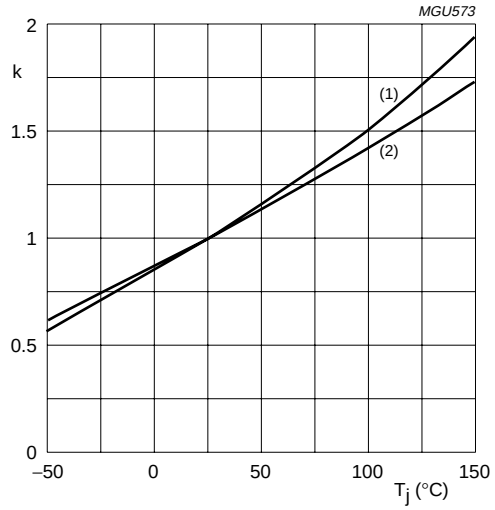
(1) V_{GS} = 2.5 V. (3) V_{GS} = 3.5 V. (5) V_{GS} = 5 V.
(2) V_{GS} = 3 V. (4) V_{GS} = 4 V. (6) V_{GS} = 10 V.

Fig.7 Drain-source on-state resistance as a function of drain current; typical values.



V_{GS} = 0; f = 1 MHz; T_j = 25 °C.

Fig.8 Input, output and feedback capacitance as functions of drain-source voltage; typical values.



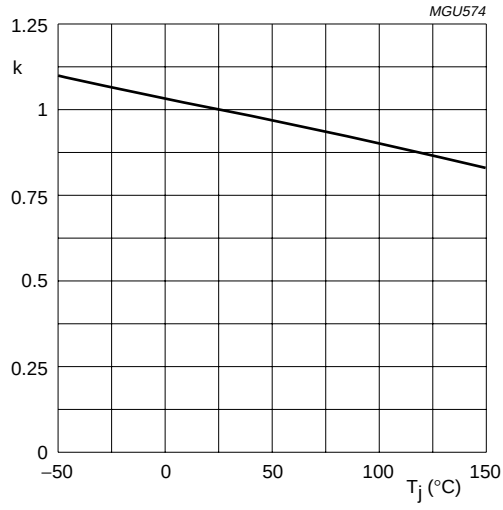
$$k = \frac{R_{DSon} \text{ at } T_j}{R_{DSon} \text{ at } 25\ °C}$$

Typical R_{DSon}:

(1) I_D = 250 mA; V_{GS} = 10 V.

(2) I_D = 20 mA; V_{GS} = 2.4 V.

Fig.9 Temperature coefficient of drain-source on-state resistance; typical values.



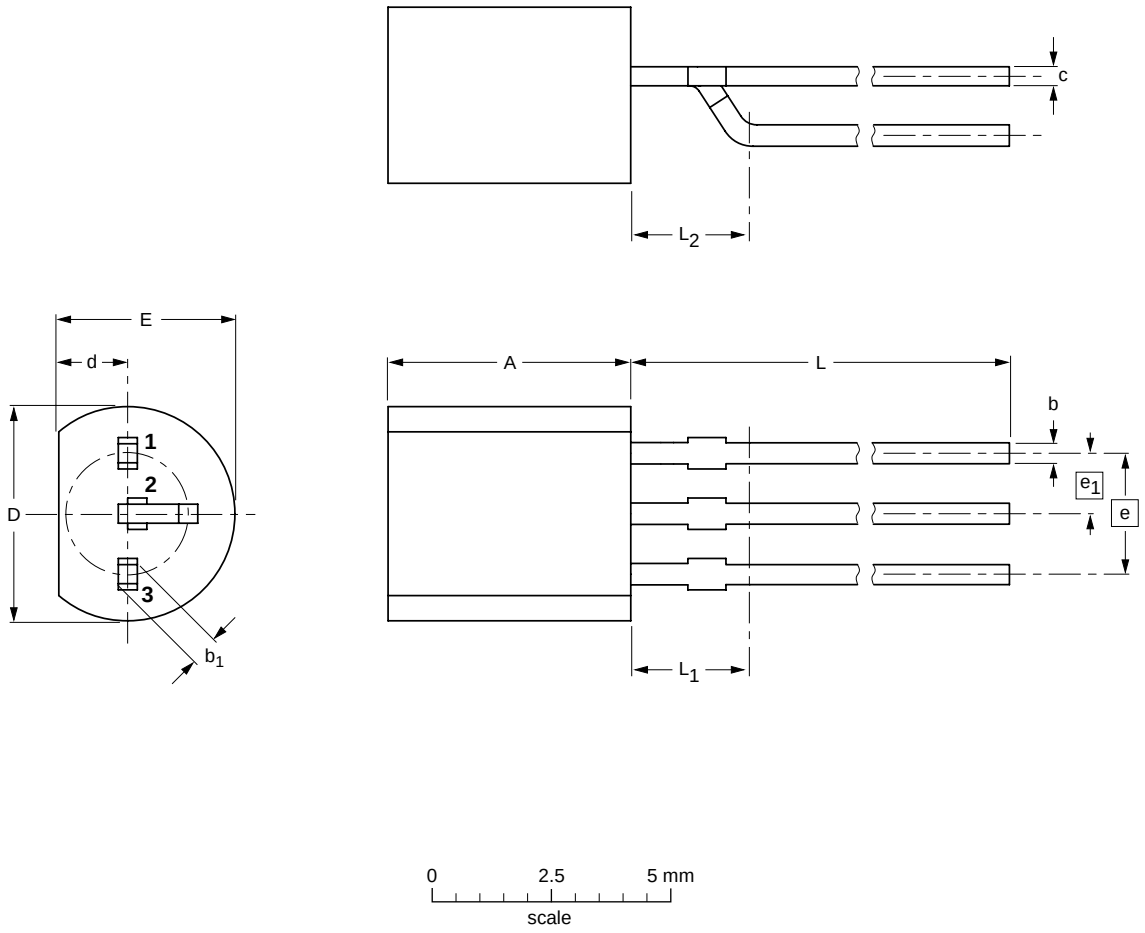
$$k = \frac{V_{GSth} \text{ at } T_j}{V_{GSth} \text{ at } 25\ °C}$$

Typical V_{GSth} at 1 mA.

Fig.10 Temperature coefficient of gate-source threshold voltage; typical values.

PACKAGE OUTLINE

Plastic single-ended leaded (through hole) package; 3 leads (on-circle) **SOT54 variant**



DIMENSIONS (mm are the original dimensions)

UNIT	A	b	b_1	c	D	d	E	e	e_1	L	L_1 (1) max	L_2 max
mm	5.2 5.0	0.48 0.40	0.66 0.56	0.45 0.40	4.8 4.4	1.7 1.4	4.2 3.6	2.54	1.27	14.5 12.7	2.5	2.5

Notes

1. Terminal dimensions within this zone are uncontrolled to allow for flow of plastic and terminal irregularities.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT54 variant		TO-92 variant	SC-43			98-03-26

DATA SHEET STATUS

DATA SHEET STATUS[1]	PRODUCT STATUS[2]	DEFINITIONS
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For additional information please visit **http://www.semiconductors.philips.com**. Fax: **+31 40 27 24825**
For sales offices addresses send e-mail to: **sales.addresses@www.semiconductors.philips.com**.

Printed in The Netherlands 613510/03/pp12 Date of release: 2002 Feb 19 Document order number: 9397 750 09312

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